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(5-2008)





Thin Film Microwave Resistor



Product may not be to scale

The MIF resistor chips on alumina are designed with low shunt capacitance. Resistor geometrics are compatible with strip lines, making them ideally suited for microwave circuits.

These chips are manufactured using Vishay Electro-Films (EFI) sophisticated thin film equipment and manufacturing technology. The MIFs are 100 % electrically tested and visually inspected to MIL-STD-883, method 2032 class H or K.

FEATURES

- Wire bondable
- · High frequency
- Small single chip size: 0.016" x 0.020"
- Case: 02016
- Microwave resistance range: 20 Ω to 100 Ω
- Overall resistance range: 20 Ω to 2 $k\Omega$
- Alumina substrate
- Low stray capacitance: < 0.2 pF
- Resistor material: Tantalum nitride, self passivating
- Moisture resistant
- Power: 50 mW
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

Vishay EFI MIF chip resistors provide excellent high frequency response and are ideally suited for prototyping. Typical application areas are:

- Amplifiers
- Oscillators
- Attenuators
- Couplers
- Filters

TEMPERATURE COEFFICIENT OF RESISTANCE, VALUES, AND TOLERANCES		
PARAMETER	VALUE	UNIT
Resistance Range	20 to 100	Ω
Tolerances	± 1, ± 5, ± 10, ± 20 standard	%
TCR	± 100	ppm/°C

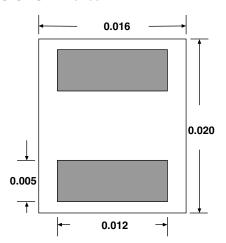
STANDARD ELECTRICAL SPECIFICATIONS		
PARAMETER	VALUE	UNIT
Noise, MIL-STD-202, Method 308	- 20 typ.	dB
Moisture Resistance, MIL-STD-202, Method 106	± 0.5 max. Δ <i>R</i> / <i>R</i>	%
Stability, 1000 h, + 125 °C, 25 mW	± 0.5 max. Δ <i>R</i> / <i>R</i>	%
Operating Temperature Range	- 55 to + 125	°C
Thermal Shock, MIL-STD-202, Method 107, Test Condition F	± 0.25 max. Δ <i>R/R</i>	%
High Temperature Exposure + 150 °C, 1000 h	± 0.5 max. Δ <i>R/R</i>	%
Dielectric Voltage Breakdown	400	V
Insulation Resistance	10 ¹² min.	Ω
Operating Voltage	100 max.	V
DC Power Rating at + 70 °C (Derated to Zero at 150 °C)	0.050 max.	W
5 x Rated Power Short-Time Overload, + 25 °C, 5 s	± 0.25 max. ΔR/R	%







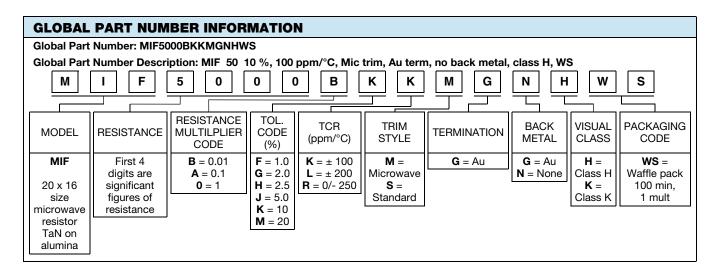
DIMENSIONS in inches



SCHEMATIC



MECHANICAL SPECIFICATIONS	
PARAMETER	
Chip Size	0.016" x 0.020" ± 0.003" (0.40 mm x 0.5 mm ± 0.076 mm)
Chip Thickness	0.010" ± 0.001" (0.25 mm ± 0.025 mm)
Chip Substrate Material	99.6 % alumina, 2 μ" to 4 μ" finish
Resistor Material	Tantalum nitride, self-passivating
Bonding Pad Size	0.005" x 0.012" (0.125 mm x 0.30 mm)
Number of Pads	2
Pad Material	25 kÅ minimum gold standard
Backing	None





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